onsemi

2-Bit 20 Mb/s Dual-Supply Level Translator NLSX0102

The NLSX0102 is a 2-bit configurable dual-supply bidirectional auto sensing translator that does not require a directional control pin. The I/O V_{CC} and I/O V_L ports are designed to track two different power supply rails, V_{CC} and V_L respectively. Both the V_{CC} and V_L supply rails are configurable from 1.65 V to 5.5 V. This allows voltage logic signals on the V_L side to be translated into voltage logic signals on the V_{CC} side, and vice-versa.

The NLSX0102 translator has integrated 10 k Ω pull-up resistors on the I/O lines. The integrated pull-up resistors are used to pull-up the I/O lines to either V_L or V_{CC}. The NLSX0102 is an excellent match for open-drain applications such as the I²C communication bus.

Features

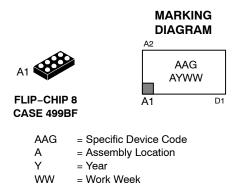
- Wide V_{CC} Operating Range: V_L to 5.5 V Wide V_L Operating Range: 1.65 V to 5.5 V
- High-Speed with 24 Mb/s Guaranteed Date Rate
- Low Bit-to-Bit Skew
- Enable Input and I/O Pins are Overvoltage Tolerant (OVT) to 5.5 V
- Non-preferential Power-up Sequencing
- Integrated 10 k Ω Pull-up Resistors
- Small Space Saving Package
 1.9 mm x 0.9 mm x 0.5 mm Flipchip8
- This is a Pb–Free Device

Typical Applications

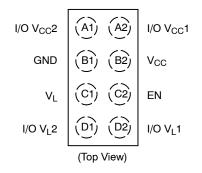
- I²C, SMBus
- Low Voltage ASIC Level Translation
- Mobile Phones, PDAs, Cameras

Important Information

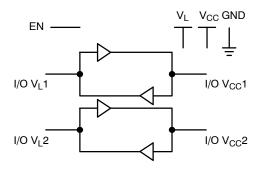
- ESD Protection for All Pins
 - Human Body Model (HBM) > 7000 V



PIN ASSIGNMENTS

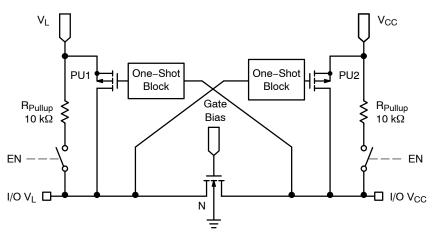


LOGIC DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.





PIN ASSIGNMENT

Pins	Description				
V _{CC}	V _{CC} Supply Voltage				
VL	V _L Supply Voltage				
GND	Ground				
EN	Output Enable, referenced to V_L				
I/O V _{CC} n	I/O Port, referenced to V_{CC}				
I/O V _L n	I/O Port, referenced to V_L				

FUNCTION TABLE

EN	Operating Mode
L	Hi–Z
Н	I/O Buses Connected

MAXIMUM RATINGS

Symbol	Parameter	Value	Condition	Unit
V _{CC}	High-side DC Supply Voltage	-0.5 to +7.0		V
VL	Low-side DC Supply Voltage	-0.5 to +7.0		V
I/O V _{CC}	V _{CC} -referenced DC Input / Output Voltage	-0.5 to +7.0		V
I/O VL	V _L -referenced DC Input / Output Voltage	-0.5 to +7.0		V
V_{EN}	Enable Control Pin DC Input Voltage	-0.5 to +7.0		V
I _{I/O_SC}	Short–Circuit Duration (I/O V_L and I/O V_{CC} to GND)	±50	Continuous	mA
I _{I/OK}	Input / Output Clamping Current (I/O V_L and I/O $V_{CC})$	-50	V _{I/O} < 0	mA
T _{STG}	Storage Temperature	-65 to +150		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Мах	Unit
V _{CC}	High-side Positive DC Supply Voltage	VL	5.5	V
VL	Low-side Positive DC Supply Voltage	1.65	5.5	V
V _{EN}	Enable Control Pin Voltage	GND	5.5	V
V _{IO}	I/O Pin Voltage	GND	5.5	V
$\Delta t/\Delta V$	Input Transition Rise and Fall Rate I/O V_L and I/O V_{CC} Ports, Push–Pull Driving		10	ns/V
	Control Input		10	
T _A	Operating Temperature Range	-40	+85	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

					-			
Symbol	Parameter	Test Conditions (Note 1)	VL	v _{cc}	Min	Typ (Notes 1, 2)	Max	Unit
V _{IHC}	I/O V _{CC} Input HIGH Voltage		1.65 to 5.5	V _L to 5.5	V _{CC} – 0.4		-	V
V _{ILC}	I/O V _{CC} Input LOW Voltage		1.65 to 5.5	V _L to 5.5			0.15	V
V _{IHL}	I/O V _L Input HIGH Voltage		1.65 to 5.5	V _L to 5.5	$V_L - 0.4$		-	V
V _{ILL}	I/O V _L Input LOW Voltage		1.65 to 5.5	V _L to 5.5			0.15	V
V _{IH}	Control Pin Input HIGH Voltage		1.65 to 5.5	V _L to 5.5	0.75 * V _L		-	V
V _{IL}	Control Pin Input LOW Voltage		1.65 to 5.5	V _L to 5.5			0.25 * V _L	V
V _{OHC}	I/O V _{CC} Output HIGH Voltage	I/O V _{CC} source current = –20 μA	1.65 to 5.5	V _L to 5.5	2/3 * V _{CC}		-	V
V _{OLC}	I/O V _{CC} Output LOW Voltage	I/O V _{CC} sink current = 1 mA	1.65 to 5.5	V _L to 5.5			0.4	V
V _{OHL}	I/O V _L Output HIGH Voltage	$I/O V_L$ source current = -20 μA	1.65 to 5.5	V _L to 5.5	2/3 * V _L		-	V
V _{OLL}	I/O V _L Output LOW Voltage	I/O V _L sink current = 1 mA	1.65 to 5.5	V _L to 5.5			0.4	V
I _{QVL}	V _L Supply Current Supply Current	I/O V _{CC} and I/O V _L unconnected, V _{EN} =	1.65 to 5.5	V _L to 5.5			2.4	μA
		VL	5.5	0			2.4	
IQVCC	V _L Supply Current Supply Current	I/O V _{CC} and I/O V _L unconnected,	1.65 to 5.5	V _L to 5.5			2.4	μA
		$V_{EN} = V_{L}$	0	5.5			2.4	
I _{TS-VCC}	V _{CC} Tri-state Output Mode	I/O V _{CC} and I/O V _L unconnected, V _{EN} = GND	1.65 to 5.5	V _L to 5.5			1.0	μΑ
I _{TS-VL}	V _L Tri-state Output Mode Supply Current	I/O V _{CC} and I/O V _L unconnected, $V_{EN} = GND$	1.65 to 5.5	V _L to 5.5			1.0	μΑ
lj –	Enable Pin Input Leakage Current		1.65 to 5.5	V _L to 5.5			1.0	μA
I _{OZ}	I/O Tri-state Output Mode Leakage Current		1.65 to 5.5	V _L to 5.5			1.0	μA
R _{PU}	Pull–Up Resistors I/O V _L and V _C					10		kΩ

DC ELECTRICAL CHARACTERISTICS (T_A = -40 to +85 $^{\circ}$ C, unless otherwise specified)

1. Typical values are for $V_{CC} = +3.3 \text{ V}$, $V_L = +1.8 \text{ V}$ and $T_A = +25^{\circ}\text{C}$. 2. All units are production tested at $T_A = +25^{\circ}\text{C}$. Limits over the operating temperature range are guaranteed by design. Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

 $\label{eq:characteristics} \begin{array}{l} \textbf{Timing Characteristics} - \textbf{Rail-to-Rail Driving Configuration} \\ (I/O \ test \ circuits \ of \ Figures \ 2, \ 3 \ and \ 7, \ C_{LOAD} = 15 \ pF, \ driver \ output \ impedance \ \leq 50 \ \Omega, \ R_{LOAD} = 1 \ M\Omega, \ unless \ otherwise \ specified) \\ \end{array}$

			-40°C to +85°C						
			V _{CC} = 2.	3 to 2.7 V	V _{CC} = 3.0	V _{CC} = 3.0 to 3.6 V		5 to 5.5 V	
Symbol	Parameter	Conditions	Min	Мах	Min	Max	Min	Max	Unit
V _L = 1.65 to 1	.95 V	•							
t _{RVL}	I/O V _L Rise Time	Figure 8	0.6	17.0	2.3	14.0	0.8	12.9	nS
t _{RVCC}	I/O V _{CC} Rise Time	Figure 8	4.0	10.8	2.2	9.1	2.7	7.6	nS
t _{FVL}	I/O V _L Fall Time	Figure 8	2.0	9.7	1.9	8.1	1.7	13.3	nS
t _{FVCC}	I/O V _{CC} Fall Time	Figure 8	2.9	13.8	2.8	16.2	2.8	16.2	nS
t _{PHL-VL-VCC}	Propagation Delay	Figure 2		7.2		7.1		10.0	nS
t _{PLH-VL-VCC}	(Driving I/O V_L , V_L to V_{CC})			6.5		7.1		7.4	
t _{PHL-VCC-VL}	Propagation Delay	Figure 3		6.0		5.3		6.7	nS
t _{PLH-VCC-VL}	(Driving I/O V_{CC} , V_{CC} to V_L)			8.0		7.6		7.1	
t _{EN}	Enable Time	Figure 7	1	50		40		35	nS
t _{DIS}	Disable Time	Figure 7		390		365		710	nS
tPPSKEW	Part-to-Part Skew			0.7		0.7		0.7	nS
MDR	Maximum Data Rate		21		22		24		Mbps
V _L = 2.3 to 2.7	7 V	•							
t _{RVL}	I/O V _L Rise Time	Figure 8	2.8	8.6	2.6	8.1	1.8	10.3	nS
t _{RVCC}	I/O V _{CC} Rise Time	Figure 8	3.2	9.2	2.9	8.8	1.9	7.7	nS
t _{FVL}	I/O V _L Fall Time	Figure 8	1.9	8.3	1.9	7.8	1.8	7.4	nS
t _{FVCC}	I/O V _{CC} Fall Time	Figure 8	2.2	8.3	2.4	8.0	2.6	10.0	nS
t _{PHL-VL-VCC}	Propagation Delay	Figure 2		4.8		5.2		6.5	nS
t _{PLH-VL-VCC}	(Driving I/O V_L , V_L to V_{CC})			5.4		5.3		6.0	
t _{PHL-VCC-VL}	Propagation Delay	Figure 3		5.0		3.9		5.4	nS
t _{PLH-VCC-VL}	(Driving I/O V _{CC} , V_{CC} to V _L)			5.5		5.0		5.5	
t _{EN}	Enable Time	Figure 7		100		40		35	nS
t _{DIS}	Disable Time	Figure 7		320		305		430	nS
t PPSKEW	Part-to-Part Skew		1	0.7		0.7		0.7	nS
MDR	Maximum Data Rate		20		22	İ	24		Mbps

Timing Characteristics – Rail-to-Rail Driving Configuration

(I/O test circuits of Figures 2, 3 and 7, C_{LOAD} = 15 pF, driver output impedance \leq 50 Ω , R_{LOAD} = 1 M Ω , unless otherwise specified)

			–40°C to +85°C						
			V _{CC} = 2.3 to 2.7 V		V _{CC} = 3.0 to 3.6 V		V _{CC} = 4.5 to 5.5 V		1
Symbol	Parameter	Conditions	Min	Max	Min	Max	Min	Max	Unit
V _L = 3.0 to 3.6	5 V						-		
t _{RVL}	I/O V _L Rise Time	Figure 8			2.3	6.5	1.9	8.0	nS
t _{RVCC}	I/O V _{CC} Rise Time	Figure 8			2.5	6.5	2.1	7.4	nS
t _{FVL}	I/O V _L Fall Time	Figure 8			1.3	7.2	1.6	11.0	nS
t _{FVCC}	I/O V _{CC} Fall Time	Figure 8			1.7	8.0	1.3	9.3	nS
t _{PHL-VL-VCC}	Propagation Delay	Propagation Delay Figure 2 Driving I/O V _L , V _L to V _{CC})				3.9		4.6	nS
t _{PLH-VL-VCC}	(Driving I/O v_L , v_L to v_{CC})					3.8		3.8	
t _{PHL-VCC-VL}	Propagation Delay	Figure 3				3.8		4.6	nS
t _{PLH-VCC-VL}	(Driving I/O V_{CC} , V_{CC} to V_L)					4.3		5.8	
t _{EN}	Enable Time	Figure 7				80		35	nS
t _{DIS}	Disable Time	Figure 7				260		385	nS
t PPSKEW	Part-to-Part Skew					0.7		0.7	nS
MDR	Maximum Data Rate				23		24		Mbps

 $\label{eq:constraint} \begin{array}{l} \textbf{Timing Characteristics} - \textbf{Open Drain Driving Configuration} \\ (I/O \ test \ circuits \ of \ Figures \ 4, \ 5 \ and \ 7, \ C_{LOAD} \ = \ 15 \ pF, \ driver \ output \ impedance \ \leq \ 50 \ \Omega, \ R_{LOAD} \ = \ 1 \ M\Omega, \ unless \ otherwise \ specified) \\ \end{array}$

			-40°C to +85°C						
			V _{CC} = 2.3	3 to 2.7 V	V _{CC} = 3.0	0 to 3.6 V	V _{CC} = 4.5	5 to 5.5 V	
Symbol	Parameter	Conditions	Min	Max	Min	Max	Min	Max	Unit
V _L = 1.65 to 1	.95 V								
t _{RVL}	I/O V _L Rise Time	Figure 8	38	340	30	245	22.0	134	nS
t _{RVCC}	I/O V _{CC} Rise Time	Figure 8	34	330	23	218	10.0	120	nS
t _{FVL}	I/O V _L Fall Time	Figure 8	4.4	11.1	4.3	12.0	4.2	14.2	nS
t _{FVCC}	I/O V _{CC} Fall Time	Figure 8	6.9	11	7.5	16.2	7.0	16.2	nS
t _{PHLVL-VCC}	Propagation Delay	Figure 2	2.3	27	2.4	20.0	2.6	23.0	nS
t _{PLHVL-VCC}	(Driving I/O V_L , V_L to V_{CC})		45	260	36.0	208	27.0	208	
t _{PHLVCC-VL}	Propagation Delay	Figure 3	1.9	22	1.1	22.0	1.2	22.0	nS
t _{PLHVCC-VL}	(Driving I/O V_{CC} , V_{CC} to V_L)		45.0	200	36	150	27.0	112	
t _{EN}	Enable Time	Figure 7		80		70		35	nS
t _{DIS}	Disable Time	Figure 7		250		277		290	nS
t _{PPSKEW}	Part-to-Part Skew			0.7		0.7		0.7	nS
MDR	Maximum Data Rate		2		2		2		Mbps

 $\label{eq:constraint} \begin{array}{l} \textbf{Timing Characteristics - Open Drain Driving Configuration} \\ (I/O test circuits of Figures 4, 5 and 7, C_{LOAD} = 15 \text{ pF}, driver output impedance} \leq 50 \ \Omega, \ R_{LOAD} = 1 \ M\Omega, unless otherwise specified) \end{array}$

			–40°C to +85°C						
			V _{CC} = 2.3 to 2.7 V V _{CC} = 3.			0 to 3.6 V	V _{CC} = 4.5 to 5.5 V		
Symbol	Parameter	Conditions	Min	Max	Min	Max	Min	Max	Unit
V _L = 2.3 to 2.3	7 V								
t _{RVL}	I/O V _L Rise Time	Figure 8	34	400	28.0	300	24.0	208	nS
t _{RVCC}	I/O V _{CC} Rise Time	Figure 8	35.0	352	24.0	280	12.0	180	nS
t _{FVL}	I/O V _L Fall Time	Figure 8	4.4	6.9	4.3	6.2	4.2	7.8	nS
t _{FVCC}	I/O V _{CC} Fall Time	Figure 8	4.3	8.8	4.9	9.4	5.4	10.4	nS
t _{PHLVL-VCC}	Propagation Delay	F i o	1.7	14.0	2.0	14.0	2.1	14.0	-
t _{PLHVL-VCC}	(Driving I/O V _L , V _L to V _{CC})	Figure 2	43.0	250	36.0	210	27.0	210	nS
t _{PHLVCC-VL}	Propagation Delay	_	1.8	13.0	2.6	13.0	1.2	13.0	-
t _{PLHVCC-VL}	(Driving I/O V _{CC} , V_{CC} to V _L)	Figure 3	44.0	225	37.0	180	27.0	144	nS
t _{EN}	Enable Time	Figure 7		50		40		35	nS
t _{DIS}	Disable Time	Figure 7		265		230		215	nS
t _{PPSKEW}	Part-to-Part Skew			0.7		0.7		0.7	nS
MDR	Maximum Data Rate		2		2		2		Mbps
V _L = 3.0 to 3.0	5 V				•	•			
t _{RVL}	I/O V _L Rise Time	Figure 8			25.0	400	19.0	278	nS
t _{RVCC}	I/O V _{CC} Rise Time	Figure 8			26.0	375	14.0	247	nS
t _{FVL}	I/O V _L Fall Time	Figure 8			2.8	6.1	2.6	5.7	nS
t _{FVCC}	I/O V _{CC} Fall Time	Figure 8			2.6	7.6	3.1	8.3	nS
t _{PHLVL-VCC}	Propagation Delay	F i o			1.3	10.0	1.4	8.0	-
t _{PLHVL-VCC}	(Driving I/O V _L , V _L to V _{CC})	Figure 2			36.0	255	28.0	243	nS
t _{PHLVCC-VL}	Propagation Delay	F			1.0	124	1.0	97.0	6
t _{PLHVCC-VL}	(Driving I/O V_{CC} , V_{CC} to V_L)	Figure 3			3.0	185	3.0	136	nS
t _{EN}	Enable Time	Figure 7				40		35	nS
t _{DIS}	Disable Time	Figure 7				250		205	nS
t _{PPSKEW}	Part-to-Part Skew					0.7		0.7	nS
MDR	Maximum Data Rate				2		2		Mbps

TEST SETUPS

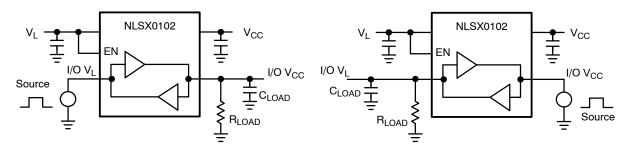




Figure 3. Rail-to-Rail Driving I/O V_{CC}

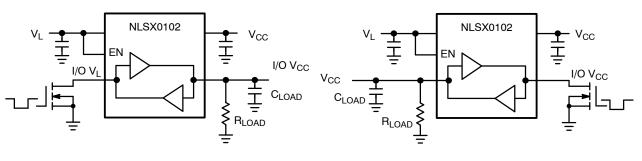


Figure 4. Open–Drain Driving I/O VL

Figure 5. Open–Drain Driving I/O V_{CC}

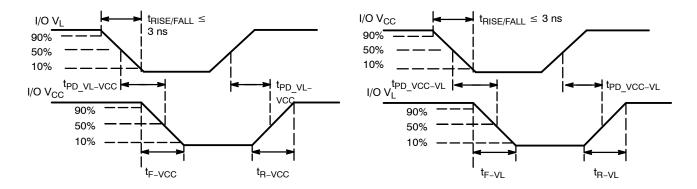
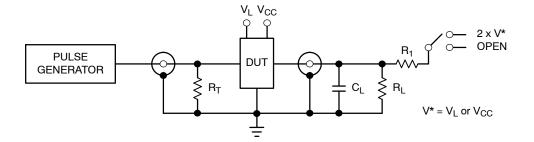


Figure 6. Definition of Timing Specification Parameters



Test	Switch
t _{PZH} , t _{PHZ}	Open
t _{PZL} , t _{PLZ}	2 x V*

 C_L = 15 pF or equivalent (Includes jig and probe capacitance) R_L = R_1 = 50 k Ω or equivalent

 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω) V* = V_L or V_{CC} for I/O_VL or I/O_VCC measurements,

respectively.



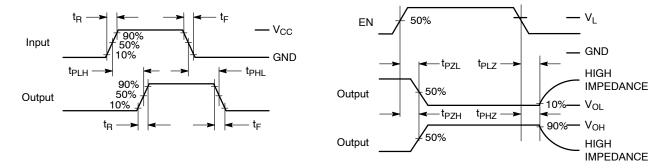


Figure 8. Timing Definitions for Propagation Delays and Enable/Disable Measurement

APPLICATIONS INFORMATION

Level Translator Architecture

The NLSX0102 auto sense translator provides bi-directional voltage level shifting to transfer data in multiple supply voltage systems. This device has two supply voltages, V_L and V_{CC} , which set the logic levels on the input and output sides of the translator. When used to transfer data from the V_L to the V_{CC} ports, input signals referenced to the V_L supply are translated to output signals with a logic level matched to V_{CC} . In a similar manner, the V_{CC} to V_L translation shifts input signals with a logic level compatible to V_{CC} to an output signal matched to V_L .

The NLSX0102 consists of two bi-directional channels that independently determine the direction of the data flow without requiring a directional pin. The one-shot circuits are used to detect the rising or falling input signals. In addition, the one shots decrease the rise and fall time of the output signal for high-to-low and low-to-high transitions. Each input/output channel has an internal 10 k Ω pull-up. The magnitude of the pull-up resistors can be reduced by connecting external resistors in parallel to the internal 10 k Ω resistors.

Input Driver Requirements

The rise (t_R) and fall (t_F) timing parameters of the open drain outputs depend on the magnitude of the pull-up resistors. In addition, the propagation times (t_{PD}) , skew (t_{PSKEW}) and maximum data rate depend on the impedance of the device that is connected to the translator. The timing parameters listed in the data sheet assume that the output impedance of the drivers connected to the translator is less than 50 k Ω .

Enable Input (EN)

The NLSX0102 has an Enable pin (EN) that provides tri-state operation at the I/O pins. Driving the Enable pin to a low logic level minimizes the power consumption of the device and drives the I/O V_{CC} and I/O V_L pins to a high impedance state. Normal translation operation occurs when the EN pin is equal to a logic high signal. The EN pin is referenced to the V_L supply and has Overvoltage Tolerant (OVT) protection.

Power Supply Guidelines

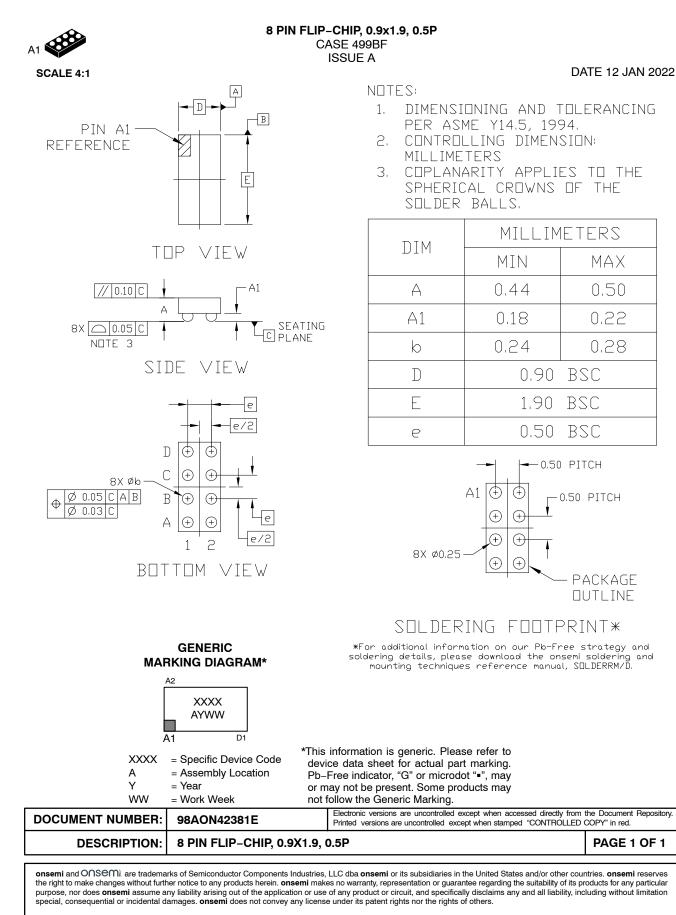
During normal operation, supply voltage V_L must be less than or equal to V_{CC} . The sequencing of the power supplies will not damage the device during the power up operation. For optimal performance, 0.01 μ F to 0.1 μ F decoupling capacitors should be used on the V_L and V_{CC} power supply pins. Ceramic capacitors are a good design choice to filter and bypass any noise signals on the voltage lines to the ground plane of the PCB. The noise immunity will be maximized by placing the capacitors as close as possible to the supply and ground pins, along with minimizing the PCB connection traces.

ORDERING I	NFORMATION
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Device	Package	Shipping [†]
NLSX0102FCT1G	Flip–Chip 8 (Pb–Free)	3000 / Tape & Reel
NLSX0102FCT2G	Flip–Chip 8 (Pb–Free)	3000 / Tape & Reel (4mm Pitch Carrier Tape)
NLSX0102FC2T2G	Flip–Chip 8 (Pb–Free)	3000 / Tape & Reel (2mm Pitch Carrier Tape)

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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